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Part Number: 0739437200

Status: Active

Overview: HDM Backplane Connector System

Description: HDM Board-to-Board Backplane Header, Vertical, Solder Tail, Closed End, 144 Circuits

**Documents:** 

<u>3D Model</u> <u>Packaging Specification PK-70873-0818 (PDF)</u>

Drawing (PDF) RoHS Certificate of Compliance (PDF)

**Agency Certification** 

CSA LR19980 UL E29179

General

Product Family Backplane Connectors

Series 73943
Application Backplane

Comments Solder Tail, Solder Tail

Component Type PCB Header

Overview HDM Backplane Connector System

Product Name HDM

UPC 800754775779

**Physical** 

Circuits (Loaded) 144
Circuits (maximum) 144

Color - Resin Black, Natural

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

None

Material - Metal Phosphor Bronze

Material - Plating Mating Gold Material - Plating Termination Tin

Material - Resin High Temperature Thermoplastic

Net Weight 6.775/g Number of Columns 24

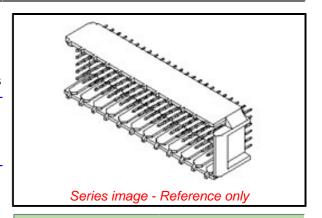
Number of Pairs Open Pin Field

Number of Rows Orientation Vertical PC Tail Length 3.50mm **PCB** Locator Nο **PCB** Retention None PCB Thickness - Recommended 2.50mm Packaging Type Tube Pitch - Mating Interface 2.00mm Pitch - Termination Interface 2.00mm Plating min - Mating 0.762µm Plating min - Termination 2.540µm Stackable Yes Surface Mount Compatible (SMC)

Temperature Range - Operating -55° to +105°C
Termination Interface: Style Through Hole

**Electrical** 

Current - Maximum per Contact 1.0A



## **EU ELV**

**Not Relevant** 

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -ED/71/2019 (16 July 2019)

Halogen-Free
Status
Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

### **Search Parts in this Series**

73943 Series

#### **Mates With**

73632 HDM+ Board-to-Board Daughtercard Receptacle. 73780 HDM Board-to-Board Daughtercard Receptacle

### Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

DescriptionProduct #Extraction Tool621001000Backplane Insertion621001400

Signal Contact Tool

1.0 Gbps Data Rate Voltage - Maximum 250V AC

**Material Info** 

**Reference - Drawing Numbers** Packaging Specification PK-70873-0818 Sales Drawing SD-73943-001

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